TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (Ultra-High-Speed U-MOSIII)

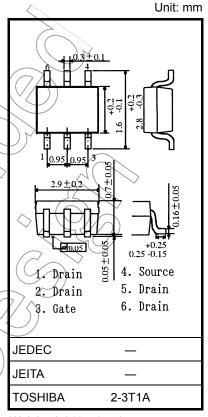
TPC6006-H

Notebook PC Applications Portable Equipment Applications

- Small footprint due to small and thin package
- High-speed switching
- Small gate charge: Qsw = 2.4 nC (typ.)
- Low drain-source ON-resistance: RDS (ON) = $59 \text{ m}\Omega$ (typ.)
- High forward transfer admittance: $|Y_{fs}| = 7 S$ (typ.)
- Low leakage current: $I_{DSS} = 10 \,\mu\text{A} \,(\text{max}) \,(V_{DS} = 40 \,\text{V})$
- Enhancement mode: $V_{th} = 1.1$ to 2.3 V ($V_{DS} = 10$ V, $I_{D} = 1$ mA)

Absolute Maximum Ratings (Ta = 25°C)

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Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	40	> V	
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V_{DGR}	40	V	
Gate-source voltage		V_{GSS}	±20	V	
Drain current	DC (Note 1)	ID <	3.9	A	
Diain current	Pulse (Note 1)	I _{DP}	15.6	$\langle \langle \rangle$	
Drain power dissipation (t = 5 s) (Note 2a)		PD	2.2	w	
		(PD)	0.7	/w	
Single pulse avalanche energy (Note 3)		EAS	7	Cm/	
Avalanche current		YAR	3.9	A	
Repetitive avalanche energy (Note 4)		EAR	0.22	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55 to 150	°C	



Weight: 0.011 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions" Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

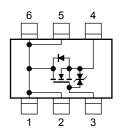
Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 5 s) (Note 2a)	R _{th (ch-a)}	56.8	°C/W
Thermal resistance, channel to ambient (t = 5 s) (Note 2b)	R _{th (ch-a)}	178.5	°C/W

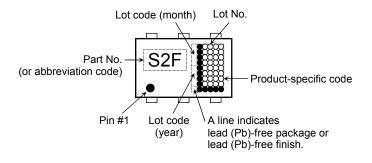
Note: (Note 1), (Note 2), (Note 3), (Note 4) and (Note 5): See the next page.

This transistor is an electrostatic-sensitive device. Handle with care.

Circuit Configuration



Marking (Note 5)



Electrical Characteristics (Ta = 25°C)

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Cha	racteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage curr	ent	I _{GSS}	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	- /	X7	±10	μΑ
Drain cut-OFF cur	rent	I _{DSS}	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$	4		> 10	μΑ
Drain source brea	kdown voltago	V _{(BR) DSS}	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	40) —	V
Drain-source breakdown voltage		V _{(BR) DSX}	$I_D = 10 \text{ mA}, V_{GS} = -20 \text{ V}$	25			V
Gate threshold vol	tage	V_{th}	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$			2.3	>
Drain-source ON resistance		D- a vavii	$V_{GS} = 4.5 \text{ V}, I_D = 1.9 \text{ A}$	$\overline{\gamma}$	78	100	- mΩ
		R _{DS} (ON)	$V_{GS} = 10 \text{ V}, I_D = 1.9 \text{ A}$	_	59	75	
Forward transfer a	dmittance	Y _{fs}	$V_{DS} = 10 \text{ V}, I_{D} = 1.9 \text{ A}$	3.5	7		S
Input capacitance		C _{iss}			251		
Reverse transfer capacitance		C _{rss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		18		pF
Output capacitance		Coss	,	_	73		
Switching time	Rise time	()	ID = 1.9 A	_	4		
	Turn-ON time	ton	VGS OVOUT	_	9		
	Fall time	tf	R = 10.5	_	3		ns
	Turn-OFF time	toff	V _{DD} ≃ 20 V Duty ≤ 1%, t _w = 10 μs	_	18	_	
Total gate charge		⟨ Q _g	$V_{DD} \simeq 32 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 3.9 \text{ A}$		4.4		
(gate-source plus gate-drain)		ag ag	$V_{DD} \simeq 32 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 3.9 \text{ A}$	_	2.4		nC
Gate-source charge 1		Q _{gs1}		_	1.0	_	
Gate-drain ("Miller") charge		\bigcirc \bigcirc \bigcirc g _d	$V_{DD} \simeq 32 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 3.9 \text{ A}$		0.8	_	
Gate switch charg	é	Q _{SW}		_	1.3	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

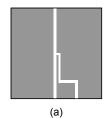
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Pulse drain reverse current	(Note 1)	I _{DRP}	_	_	_	15.6	Α
Forward voltage (Diode)		V_{DSF}	I _{DR} = 3.9 A, V _{GS} = 0 V	_	_	-1.2	V

3

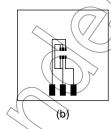
Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (a)

(b) Device mounted on a glass-epoxy board (b)



FR--4 $25.4 \times 25.4 \times 0.8$ Unit: (mm)



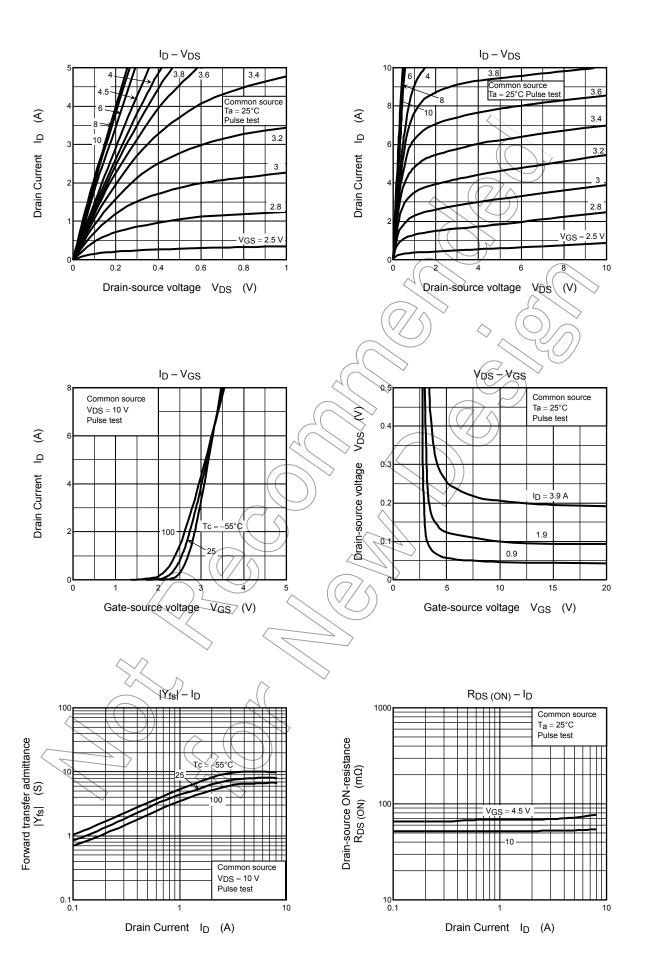
FR-4 25.4 × 25.4 × 0.8 Unit: (mm)

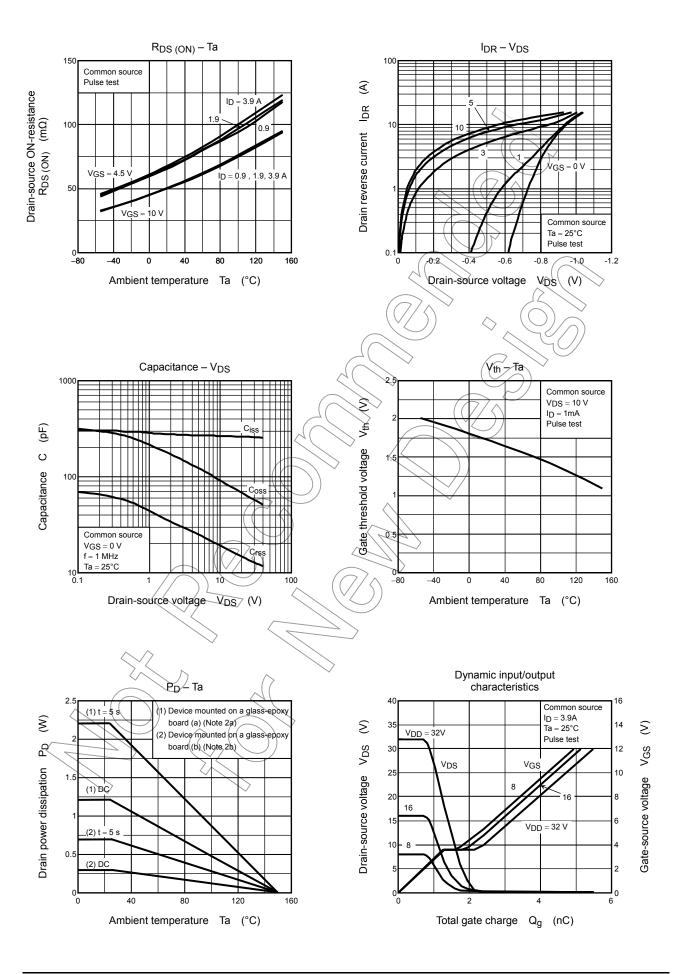
Note 3: $V_{DD} = 24 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), L = 0.5 mH, $R_G = 25 \Omega$, $L_{AR} = 3.9 \text{ A}$

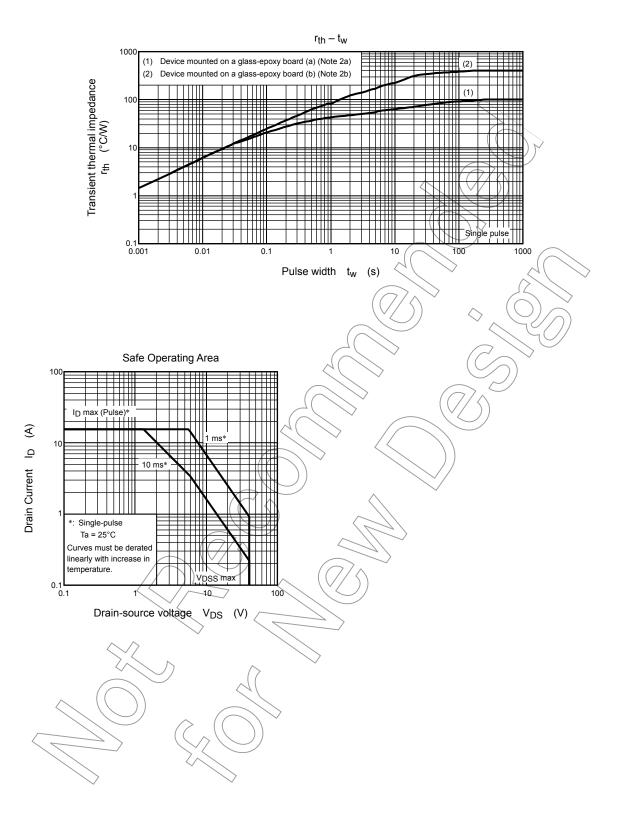
Note 4: Repetitive rating: pulse width limited by maximum channel temperature

Note 5: • on lower left of the marking indicates Pin 1.











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20070701-EN

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2007-12-20